

General Description

The DMTH6004LPS-13 use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness.



DFN5X6-8L

General Features

V_{DS} =60V I_D =125A

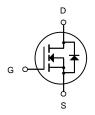
 $R_{DS(ON)}$ < 2.9m Ω @ V_{GS} =10V

Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
DMTH6004LPS-13	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (T_C =25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	60	V
Vgs	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V	А	
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V	101	А
Ірм	Pulsed Drain Current ²	641	А
EAS	Single Pulse Avalanche Energy ³	189	mJ
P _D @T _C =25°C	Total Power Dissipation ⁴	113	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R _θ JC	Thermal Resistance from Junction-to-Ambient ³	1.11	°C/W
R ₀ JA	Thermal Resistance Junction-Ambient ¹	39.4	°C/W



Electrical Characteristics (T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V,	-	-	1.0	μA
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} = ±20V	-	_	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	1.2	1.6	2.2	V
R _{DS(on)}	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =20A	-	2.4	2.9	mΩ
C _{iss}	Input Capacitance	\/ -20\/\/ -0\/	-	4610	6915	pF
Coss	Output Capacitance	V _{DS} =30V,V _{GS} =0V, f=1.0MHz	-	2188	3282	pF
Crss	Reverse Transfer Capacitance	I-I.UIVITZ	-	66	132	pF
Qg	Total Gate Charge	\/ -20\/ -40A	-	74.37	111.56	nC
Q _{gs}	Gate-Source Charge	V_{DS} =30V, I_{D} =40A, V_{GS} =10V	-	17.26	-	nC
Q _{gd}	Gate-Drain("Miller") Charge	VGS-10V	-	9.44	18.88	nC
t _{d(on)}	Turn-on Delay Time		-	14.13	-	ns
t _r	Turn-on Rise Time	V _{DD} =30V, I _D =40A,	-	63.73	-	ns
t _{d(off)}	Turn-off Delay Time	$R_G=2.7\Omega, V_{GS}=10V$	-	46.8	-	ns
t f	Turn-off Fall Time		-	105.07	-	ns
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	125	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	641	Α
V _{SD}	Drain to Source Diode Forward	V _{GS} =0V, I _S =40A	-	-	1.2	V
	Voltage	33 - 1 , 13 - 13 - 1				
t _{rr}	Body Diode Reverse Recovery Time	 Tյ=25℃,	-	52.78	105.56	ns
Qrr	Body Diode Reverse Recovery Charge	I _F =40A,dI/dt=100A/μs	-	56.31	112.62	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition: $T_J = 25\,^{\circ}\mathrm{C}$, $V_{DD} = 30V$, $V_G = 10V$, $R_G = 25\Omega$, L = 0.5mH , $I_{AS} = 12A$
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Characteristics

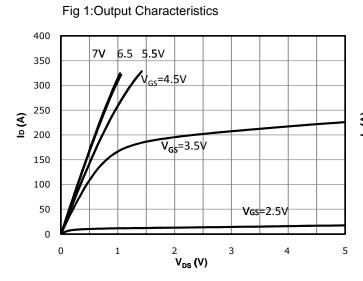


Fig 2:Transfer Characteristics

V_{DS}=5V

V_{DS}

Vgs(V)

Fig 3: Rds(on) vs Drain Current and Gate Voltage

4.0

3.5

3.0

V_{GS}=10V

2.5

2.0

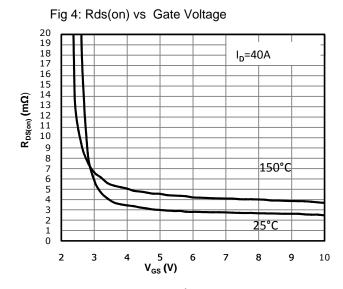
1.5

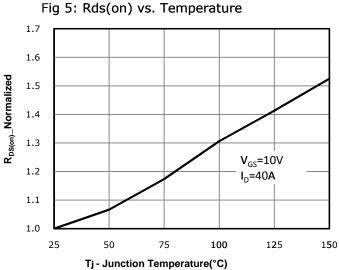
1.0

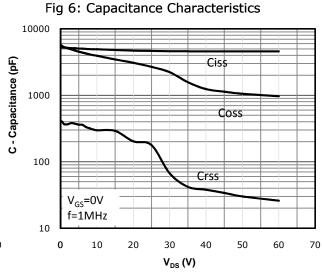
0

50

100







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Fig 7:Gate Charge Characteristics

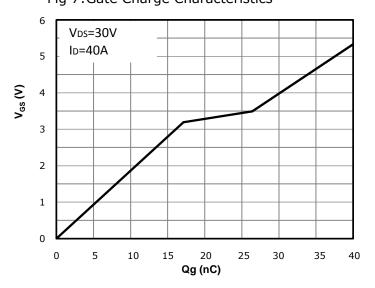


Fig 8: Body-diode Forward Characteristics

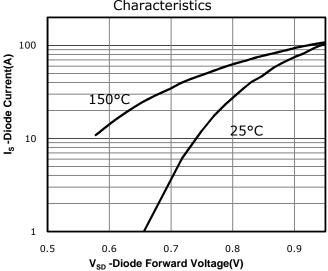


Fig 9: Power Dissipation

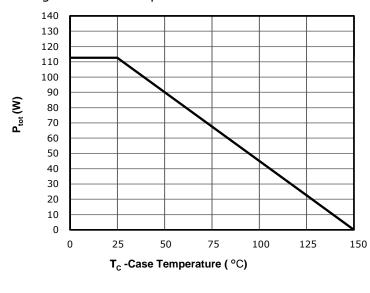


Fig 10: Drain Current Derating

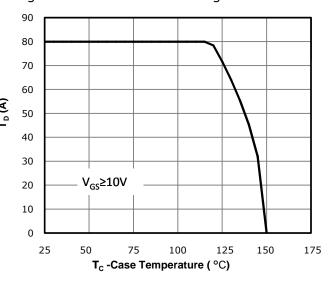
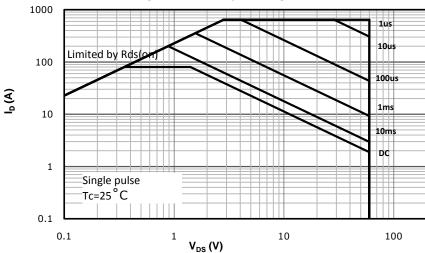
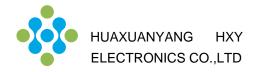
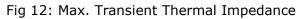
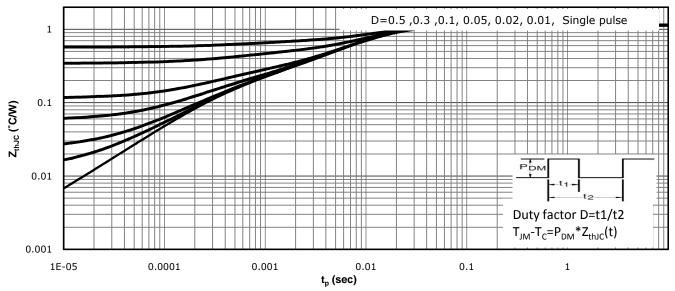


Fig 11: Safe Operating Area

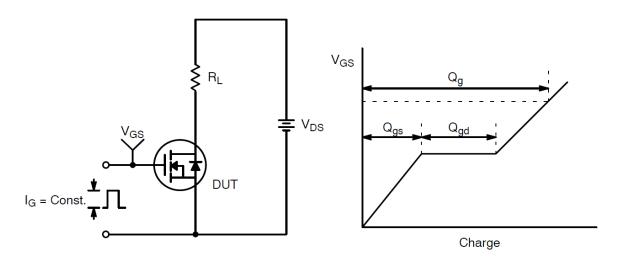




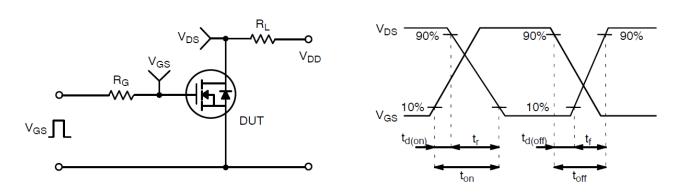




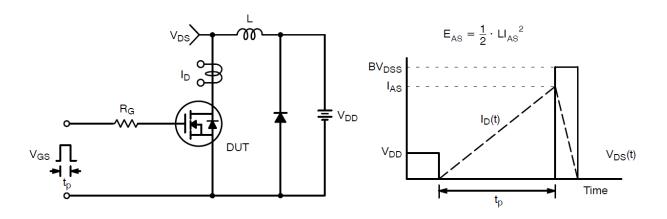
Test Circuit and Waveform:



Gate Charge Test Circuit & Waveform



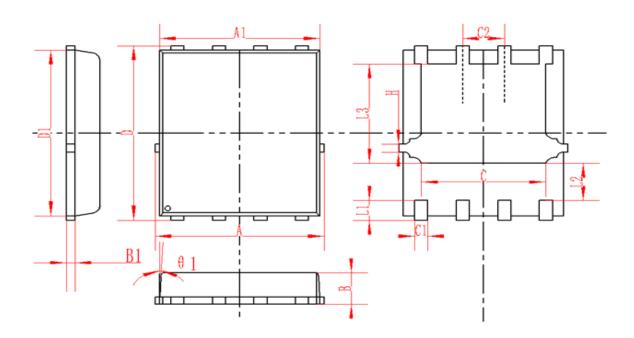
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



DFN5X6-8L Package Information



SYMBOL	MM		INCH			
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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